

FDD6688/FDU6688

30V N-Channel PowerTrench^o MOSFET

General Description

FAIRCHILD SEMICONDUCTOR

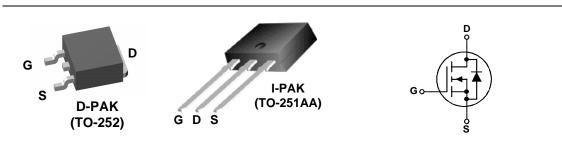
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

Applications

- DC/DC converter
- Motor Drives

Features

- 84 A, 30 V. $R_{DS(ON)} = 5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 6 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge
- Fast switching
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$



Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbo I	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	
I _D	Drain Current – Continuous	(Note 3)	84	А
	– Pulsed	(Note 1a)	100	
PD	Power Dissipation for Single Operation	(Note 1)	83	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +175	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	
		(Note 1b)	96	

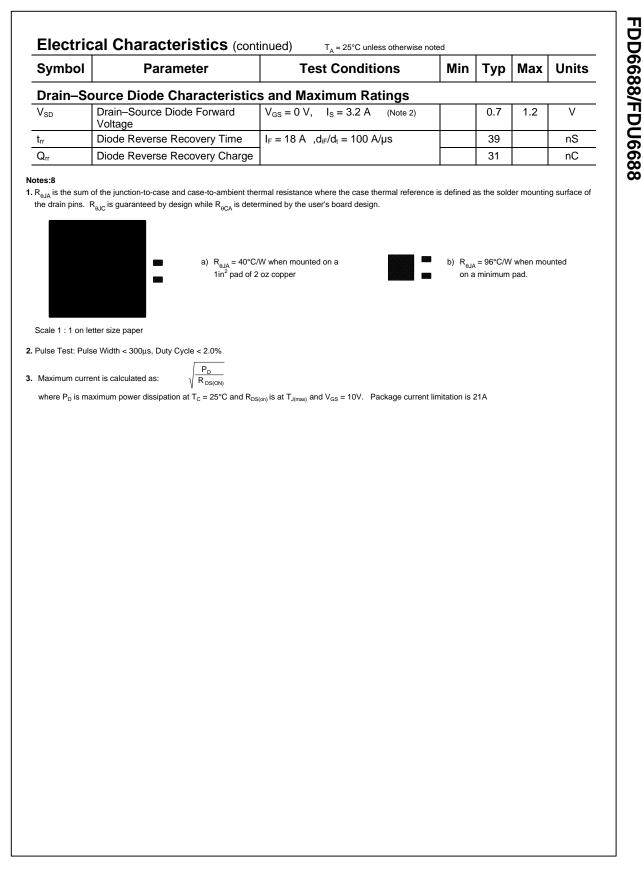
Package Marking and Ordering Information

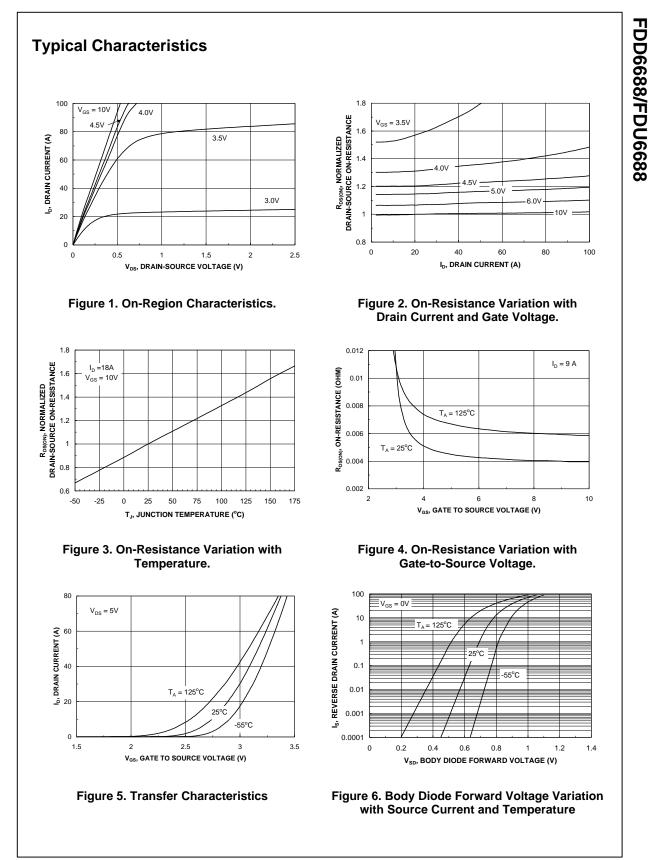
Device Marking	Device	Package	Reel Size	Tape width	Quantity
FDD6688	FDD6688	D-PAK (TO-252)	13"	12mm	2500 units
FDU6688	FDU6688	I-PAK (TO-251)	Tube	N/A	75

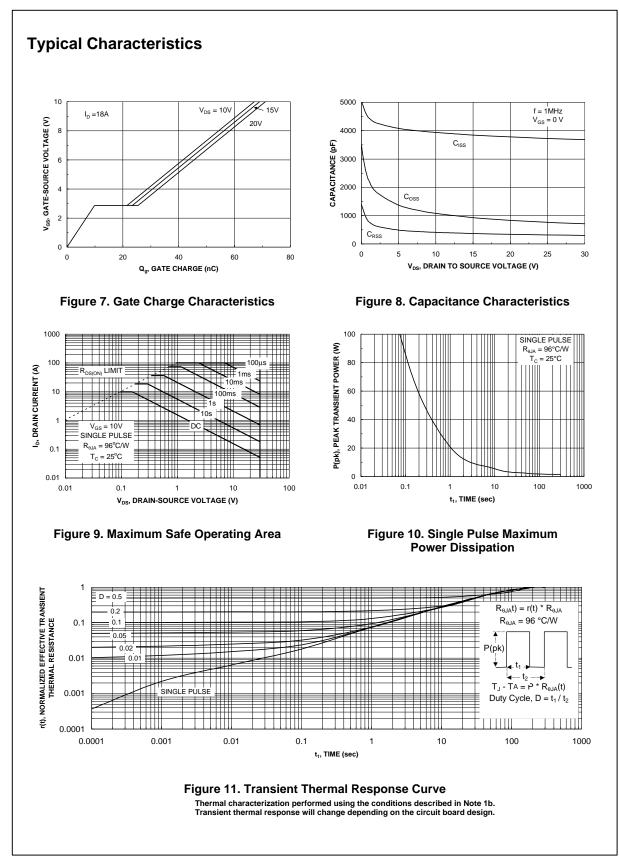
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Parameter	Test Conditions	Min	Тур	Max	Units
urce Avalanche Ratings (No	ote 2)				
Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$, $I_D = 2$	1A		370	mJ
Drain-Source Avalanche Current				21	А
acteristics			•		
Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_D = 250 \mu\text{A}$	30			V
Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°	С	24		mV/°C
Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
Gate-Body Leakage	$V_{GS}=\pm 20~V, \qquad V_{DS}=0~V$			±100	nA
Acteristics (Note 2)					
Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \qquad I_{\text{D}} = 250 \; \mu\text{A}$	1	1.8	3	V
Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°	С	-5		mV/°C
Static Drain–Source	$V_{GS} = 10 \text{ V}, \qquad I_D = 18 \text{ A}$		4	5	mΩ
On-Resistance		C		-	
On–State Drain Current		50	Ŭ	10	А
Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 18 A$		88		S
Characteristics					
	$V_{DS} = 15 V$. $V_{CS} = 0 V$.		3845		pF
	f = 1.0 MHz				pF
• •					pF
•	$V_{cs} = 15 \text{ mV}$ f = 1.0 MHz				Ω
				l	
	$V_{\rm res} = 15 V$ $I_{\rm r} = 1.4$		15	27	ns
					ns
					ns
•			-		ns
	$V_{DS} = 15V, I_{D} = 18 A,$		37	56	nC
Gate–Source Charge	$V_{GS} = 5 V$		10		nC
Gate–Drain Charge			14		nC
	Drain-Source Avalanche Current Acteristics Drain-Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate-Body Leakage Acteristics (Note 2) Gate Threshold Voltage Gate Threshold Voltage Gate Threshold Voltage Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain-Source On-Resistance On-State Drain Current Forward Transconductance Characteristics Input Capacitance Output Capacitance Gate Resistance Gate Resistance Gate Resistance Gate Resistance Gate Resistance Gate Resistance Gate Resistance Durn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	Drain-Source Avalanche CurrentacteristicsDrain-Source Breakdown $V_{GS} = 0 \ V$, $I_D = 250 \ \mu A$ VoltageI_D = 250 \ \mu A, Referenced to 25°Breakdown Voltage TemperatureI_D = 250 \ \mu A, Referenced to 25°CoefficientV_DS = 24 V, V_{GS} = 0 VGate-Body LeakageV_GS = ±20 V, V_DS = 0 VGate-Body LeakageV_DS = 24 V, V_DS = 0 VGate Threshold VoltageI_D = 250 \ \mu A, Referenced to 25°Gate Threshold VoltageI_D = 250 \ \mu A, Referenced to 25°Temperature CoefficientI_D = 250 \ \mu A, Referenced to 25°Static Drain-SourceV_GS = 10 V, I_D = 18 AOn-ResistanceV_GS = 10 V, I_D = 18 A, T_J=125°On-State Drain CurrentV_GS = 10 V, V_DS = 5 VForward TransconductanceV_DS = 5 V, I_D = 18 ACharacteristicsInput CapacitanceInput CapacitanceV_DS = 15 V, V_GS = 0 V, f = 1.0 MHzReverse Transfer CapacitanceV_GS = 15 mV, f = 1.0 MHz Characteristics (Note 2)Turn-On Delay TimeV_DD = 15 V, I_D = 1 A, V_GS = 10 V, R_GEN = 6 \OmegaTurn-Off Delay TimeV_DS = 15V, V_GS = 6 \OmegaTurn-Off Fall TimeV_DS = 5 VTotal Gate ChargeV_DS = 5 VV_GS = 5 VV_DS = 5 V	Drain-Source Avalanche CurrentImage: Source Avalanche CurrentImage: Source BreakdownVGS = 0 V, ID = 250 μ A30Drain-Source Breakdown VoltageID = 250 μ A, Referenced to 25°C30Breakdown Voltage TemperatureID = 250 μ A, Referenced to 25°C30CoefficientID = 250 μ A, Referenced to 25°C30Zero Gate Voltage Drain CurrentVDS = 24 V, VDS = 0 V30Gate-Body LeakageVDS = $\pm 20 V$, VDS = 0 V30Cteristics (Note 2)Gate Threshold VoltageID = 250 μ A, Referenced to 25°CTemperature CoefficientID = 250 μ A, Referenced to 25°CStatic Drain-SourceVGS = 10 V, ID = 18 AOn-ResistanceVGS = 10 V, ID = 18 A, TJ = 125°COn-State Drain CurrentVGS = 10 V, VDS = 5 VVos = 10 V, ID = 18 A, TJ = 125°C50Forward TransconductanceVDS = 5 V, ID = 18 ACharacteristicsInput CapacitanceVDS = 15 V, VGS = 0 V, f = 1.0 MHzGate ResistanceVGS = 15 mV, f = 1.0 MHz gCharacteristics (Note 2) Turn-On Rise TimeTurn-On Rise TimeVDD = 15 V, ID = 1 A, Turn-On Rise TimeTurn-Off Delay TimeVDS = 15V, VDS = 6 \OmegaTurn-Off Fall TimeVDS = 15V, VDS = 6 \OmegaTurn-Off Fall TimeVDS = 15V, VDS = 15V, VDS = 18 A, VDS = 5 VTotal Gate ChargeVDS = 15V, VDS = 18 A, VDS = 5 VGate-Source ChargeVDS = 15V, VDS = 18 A, VDS = 5 V	Drain-Source Avalanche CurrentVasDrain-Source Breakdown VoltageVas $V_{as} = 0 V$, $I_{b} = 250 \mu A$ 30Breakdown Voltage Temperature Coefficient $I_{b} = 250 \mu A$, Referenced to $25^{\circ}C$ 24Zero Gate Voltage Drain Current Gate-Body Leakage $V_{as} = 24 V$, $V_{as} = 0 V$ 6Gate-Body Leakage $V_{as} = \pm 20 V$, $V_{bs} = 0 V$ 7Certristics (Note 2)Note 2)7Gate Threshold Voltage Static Drain-Source $I_{b} = 250 \mu A$, Referenced to $25^{\circ}C$ -5Static Drain-Source On-Resistance $V_{as} = 10 V$, $I_{b} = 18 A$ 4On-Resistance $V_{as} = 10 V$, $I_{b} = 18 A$, $T_{a}=125^{\circ}C$ 6On-State Drain Current $V_{as} = 10 V$, $V_{bs} = 5 V$ 50Forward Transconductance $V_{Ds} = 5 V$, $I_{b} = 18 A$ 88Characteristics10 V, $V_{as} = 15 V$, $V_{as} = 0 V$, $Gas = 10 MHz$ 368Gate Resistance $V_{as} = 15 V$, $V_{as} = 0 V$, $Gas = 0 V$, $I_{b} = 18 A$ 368Gate Resistance $V_{as} = 15 V$, $V_{as} = 0 V$, $Gas = 0 V$, $I_{a} = 1.0 MHz$ 368Gate Resistance $V_{as} = 15 V$, $V_{as} = 0 V$, $Gas = 10 MHz$ 12Turn-On Delay Time Turn-On Rise Time $V_{as} = 10 V$, $R_{geN} = 6 \Omega$ 13Turn-Off Fall Time Gas 3636Total Gate Charge Gate-Source Charge $V_{as} = 5 V$ $I_{b} = 18 A$, $Gas = 5 V$ 37	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$

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